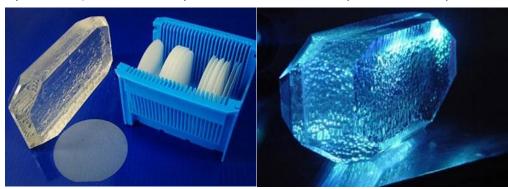
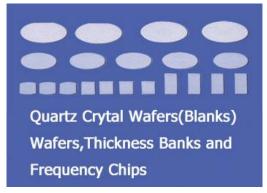


Quartz (SiO2) Crystals and Wafers

Hangzhou Shalom EO offers the SAW grade quartz materials and wafers, advanced facilities are equipped for crystals growing, wafer cutting, wafer lapping, wafer polishing and wafer checking, all finished products are passed at Testing of curie Temp and QC inspections. The quartz crystals boules, crystals blanks, wafer blanks and polished wafers are available upon customer's request.





Quartz Crystals Specifications

Quartz Crystals Specifications			
Materials	both Pure Z and Y bar available		
synthetic Q Value	min 1.8 , 2.4 to 3.0 mil IEC		
Etch channel density	max 15/cm2 max100/cm2; max300/cm2		
Stress	No dark or discolored visible in polarized light		
Surface finishing	#1000, #2000, #3000 , #4000, and Polished std		
Angle Tolerance	ZZ': +/-15" +/-30", +/-1' +/-2'		
XX'	+/-15 , +/-30'		
Cut type	AT. BT. IT ,SC,,etc.		
Freqency	1Mhz up to 50 Mhz for AT-fundamental		
Size for round blank	from 3.0 to 15.0 mm dia (with flat)		
Size for wafer	2.0x8.0 (mm)~ 16x16(mm)		
SMD type	2.5x3.0 above at Customer option.		
Flat	as request the flat shall be prependicular to X axias within +/- 10 deg		
new developed	SC-cut and LiTao3 blank & Convex blank(plano-convex) for SC-cut : theta angle: +/-30" and Phi angle : +/-3'		



Specifications for 3"/4"/5"/6" quartz wafers

Specifications for 3"/4"/5"/6" quartz wafers					
Wafer Size	3″	4"	5"	6"	
Diameter(mm)	76.2	100mm	125mm	150mm	
Tolerance (±mm)	0.25	0.5	0.5	0.5	
Primary reference flat (mm)	22mm or customized	32.5mm or customized	42.5mm or customized	57.5mm or customized	
LTV (5x5mm) (µm)	<2	<2	<2	<2	
TTV (µm)	<8	<10	<15	<20	
Bow (µm)	±20	±25	±40	±40	
Warp(µm)	≤30	≤40	≤50	≤50	
PLTV (%) (5x5mm)	≥90%	≥90%	≥90%	≥90%	
Cutting Angle	AT36/ST42.75/X/Y/Z etc.				
Orientation Flat	All available				
Surface Type	Single side polished/Double sides polished				
Polished side Ra (nm)	≤1				
Back Side Criteria (μm)	Gerneral is 0.2-0.5 or as customized				
Edge Rounding	Compliant with SEMI M1.2 Standard/refer to IEC62276				
		None			
	I	≤30			
Appearance	Si	None			
	Scratch			None	
	Cracks, cr	None			



1. Physical properties of synthetic crystal quartz

Physical properties of synthetic crystal quartz				
Density, g/cm3	2.65			
Melting point, °C	1467			
Thermal conductivity, $W/(m \times K) (T =$	10.7 (parallel to axis Z)			
25°C)	6.2 (perpendicular to axis Z)			
Thermal conductivity, $W/(m \times K) (T =$	7.1 õ 10-6 (parallel to axis Z)			
25°C)	13.2 õ 10-6 (perpendicular to axis Z)			
Hardness (Mohs)	7			
Specific heat capacity, J/(kg x K) (T = 25°C)	710			
Specific heat capacity, J/(kg x K) (T =	4.34 (parallel to axis Z)			
25°C)	4.27 (perpendicular to axis Z)			
Young's modulus (E), GPa	4.34 (parallel to axis Z)			
Tourig's modulus (L), Gra	4.27 (perpendicular to axis Z)			
Shear modulus (G), GPa	31.14			
Bulk modulus (K), GPa	36.4			
Chemical stability	insoluble in water			
Elastic coefficients	C11=87 C12=7 C44=58 C13=13 C14=18 C33=106			

2. Synthetic crystal quartz refractive index vs wavelength

	Synthetic crystal quartz refractive index vs wavelength							
λ,μm	n0	ne	λ,μm	n0	ne	λ,μm	n0	ne
0.185	1.676	1.690	0.243	1.605	1.617	0.589	1.544	1.553
0.194	1.660	1.673	0.263	1.593	1.604	1.083	1.534	1.543
0.204	1.643	1.656	0.291	1.581	1.591	1.800	1.524	1.532
0.219	1.625	1.637	0.340	1.567	1.577	2.500	1.512	1.520
0.231	1.614	1.626	0.405	1.557	1.567	3.000	1.500	1.507



1. Materials

This material consists of single-crystal right-handed a-quartz artificially grown bars which is intended for use in fabrication of piezoelectric for such as timing freq control and frequency selection under hydro-thermal condition on a seed with its length along the Y axis. This cultured quartz crystal shall have nominal Q specification defined by followed grade: Grade Q-VALUE: Specification of the synthetic quartz crystal:

Specification of quartz crystal					
Infrared absorption a 3585	≤ 0.024	≤ 0.024	≤ 0.05	≤ 0.05	
Q x10 6	3.0	3.0	2.4	2.4	
Inclusions density	I	I	I	I or II	
Etch channel density (strips/cm 2)	≤10	≤30	≤100	≤100	

2. Quality evaluation of synthetic quartz crystal

- **2.1** The amount of crystal defect and impurity in synthetic quartz crystal depends on growth rate, mineralizer and raw material. The growth rate affects greatly to the important properties such as infra-red absorption coefficient α , which correlates to Q value, and frequency –temperature characteristics. The larger growth rate causes increase in α , decrease in Q value, and dispersion in frequency-temperature characteristics.
- **2.2** The quality index of synthetic quartz crystal was originally a Q value, and a 5 MHz quartz crystal unit operated in 5th overtone mode was used to obtain the Q value. But it required laborious work to fabricate the 5 MHz crystal unit, so the index had been changed to the coefficient a instead of the Q value

3. Standard specification for synthetic quartz crystal

- **3.1** Twinning: There shall be no electrical or optical twinning in the usable region.
- **3.2** Strain: There shall be no strain contained both inside and surface of seed crystal as well as in a grown quartz crystal.
- **3.3** Cracks and fractures: There shall be no cracks, chippings or fractures in the usable region.
- **3.4** Inclusion density: The specification is in accordance with the IEC 60758.

Size range	Q'ty per cm3					
(µm) Grade	10 to 30	30 to 70	70 to 100	>100		
Ia	2	1	0	0		
Ib	3	2	1	1		
Ι	6	4	2	2		
II	9	5	4	3		
III	12	8	6	4		

3.5 Infra-red quality indication: The specification is in accordance with the IEC 60758.

Grade	Max. 伪 3585	Estimated Q values (x 106)
А	0.015	3.8
А	0.024	3.0
В	0.050	2.4
С	0.069	1.8
D	0.100	1.4



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3.6 Etch channel density: The specification is in accordance with the IEC 60758.

Grade	Max. number per cm3
1	10
2	30
3	100
4	300
5	600

4. Specification for lumbered quartz crystal:

4.1 Angles:

5.1.1 Rotation angle of X-surface around Y-axis: 00°00′±15′

5.1.2 Rotation angle of X-surface around Z-axis: 00°00′±15′

4.2 Dimensional tolerance:

5.2.1 along X or Z axis: ±0.1 mm

5.2.2 along Yaxis:±10 mm

4.3 Surface roughness: as customized ,lapped and polished are both available.

